## Effect of V-incorporated NiO Hole Transport Layer on the Performance of Inverted Perovskite Solar Cells

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### Introduction

Organic-inorganic hybrid perovskite solar cells have resulted in tremendous interest in developing future generation solar cells due to high efficiency exceeding 25%. For inverted type perovskite solar cells, the hole transporting layer plays a crucial role in improving efficient and stable perovskite solar cells by modifying band alignment, electric conductivity, and interfacial recombination losses. Here, vanadium doped NiO is selected as a hole transporting layer to study the impact of V dopant on the optoelectronic properties of NiO and the photovoltaic performance. The V-doped NiO used as a hole-extraction layer can be pre pared by the simple solvothermal decomposition method. The presence of V in the NiO layer has an influence on the conductivity of the NiO layer. In addition, the NiO with ~ $6\pm0.5$  nm particle thickness preve nts a lot of pinholes inside the film and relatively low processing temperature has the advantage of a wide choice of transparent conductive oxide substrate. As a result, inverted type planar perovskite solar cell i ncorporating of V:NiO hole-transport layer is improved over all power conversion efficiency and stability of both small area and large area of the devices.

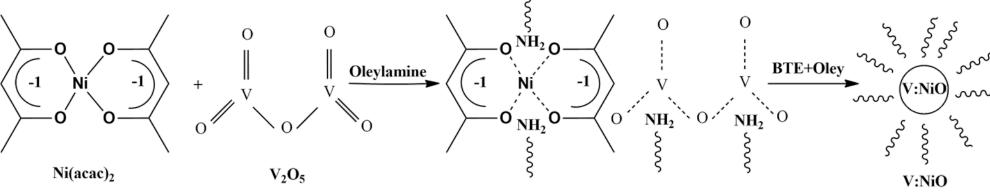
#### Originality & Scientific Impact

- Inverted perovskite solar cells based on V:NiO nanoparticles as hole transport layer.
- ► Large area devices with a new method for device integration.

**1. Material Analysis** 

Continuous light illumination stability.

**1.** V doped nickel oxide (NiO) nanoparticles were synthesized by the solvothermal decomposition method, as shown in the scheme.



Methods

2. For the integration of PSCs the surface of FTO substr ate (7-8  $\Omega$  sq<sup>-1</sup>) etched alternatively to separate anode an d cathode of each cell, Briefly, in a 5.5X5.5 cm<sup>2</sup> FTO su bstrate partitioned vertically as 3 equal compartments by

a simple wet etching procedure. Then, again performed alternative etching horizontally on the top and botto m sides of the FTO substrate. Then, the patterned FTO substrate was cleaned by sequentially sonicating in d eionized water, ethanol and acetone for15 minutes each. Followed by the treatment of ultraviolet-ozone (10 min) was performed on the substrate just before the deposition of layers.

